

**ADDENDUM TO THE BOARD OF REGENTS LOUISIANA MATERIALS DESIGN  
ALLIANCE (LAMDA) SEED FUNDING TRACK 1B: COLLABORATIVE  
PARTNERSHIP AWARD FY 23-24 REQUEST FOR PROPOSALS**

Due to extensive delays resulting from fiscal year end, the deadline for submission of proposals to the LAMDA Seed Funding Track 1B: Collaborative Partnership Award has been changed from Friday, July 7, 2023, at 4:30 p.m. Central to **Monday, July 17, 2023, at 4:30 p.m. Central**. All other requirements contained in the RFP remain as previously published. The affected sections of the RFP are cited below, with the revised deadline noted in red.

**DEADLINE DATES:**

**RFP ISSUE DATE: (May 5, 2023)**

**Last day for questions and answers about this RFP: (June 19, 2023)**

**Proposals due: (July 17, 2023, 4:30 PM Central Time)**

**Schedule**

|                                |                                   |
|--------------------------------|-----------------------------------|
| Request for Proposals Released | May 5, 2023                       |
| Last Day for Q&A               | June 19, 2023                     |
| Proposals Due                  | July 17, 2023                     |
| Award Notification             | August 1, 2023                    |
| Project Dates                  | August 15, 2023 – August 14, 2024 |

**Proposal Submission**

The proposal must be submitted by the PI to the Board of Regents through the LA EPSCoR online submission system, <https://laepscor.piestar-rfx.com/opportunities>, no later than the close of business day (4:30 p.m.) on **Monday, July 17, 2023**. All proposals must include a certification letter that the proposal has been approved by the submitting institution's authorized representative, see requirement in the Proposal Format section above.